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### Understanding [Embedded - FPGAs \(Field Programmable Gate Array\)](#)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

### Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

#### Details

|                                |   |
|--------------------------------|---|
| Product Status                 | Obsolete  |
| Number of LABs/CLBs            | 128300  |
| Number of Logic Elements/Cells | 340000  |
| Total RAM Bits                 | 19456000  |
| Number of I/O                  | 696   |
| Number of Gates                | -   |
| Voltage - Supply               | 0.82V ~ 0.88V   |
| Mounting Type                  | Surface Mount   |
| Operating Temperature          | -40°C ~ 100°C (TJ)  |
| Package / Case                 | 1517-BBGA, FCBGA  |
| Supplier Device Package        | 1517-FBGA (40x40)   |
| Purchase URL                   | <a href="https://www.e-xfl.com/product-detail/intel/5sgxea3k2f40i2ln">https://www.e-xfl.com/product-detail/intel/5sgxea3k2f40i2ln</a> |

**Table 13. OCT Variation after Power-Up Calibration for Stratix V Devices (Part 2 of 2) <sup>(1)</sup>**

| Symbol | Description  | V <sub>CCIO</sub> (V) | Typical | Unit              |
|--------|--|-----------------------|---------|-------------------|
| dR/dT  | OCT variation with temperature without recalibration | 3.0                   | 0.189   | %/ <sup>o</sup> C |
|        |  | 2.5                   | 0.208   |                   |
|        |  | 1.8                   | 0.266   |                   |
|        |  | 1.5                   | 0.273   |                   |
|        |  | 1.2                   | 0.317   |                   |

**Note to Table 13:**

(1) Valid for a V<sub>CCIO</sub> range of  $\pm 5\%$  and a temperature range of 0° to 85°C.

**Pin Capacitance**

Table 14 lists the Stratix V device family pin capacitance.

**Table 14. Pin Capacitance for Stratix V Devices**

| Symbol             | Description  | Value | Unit |
|--------------------|--|-------|------|
| C <sub>IOTB</sub>  | Input capacitance on the top and bottom I/O pins                 | 6     | pF   |
| C <sub>IOLR</sub>  | Input capacitance on the left and right I/O pins                 | 6     | pF   |
| C <sub>OUTFB</sub> | Input capacitance on dual-purpose clock output and feedback pins | 6     | pF   |

**Hot Socketing**

Table 15 lists the hot socketing specifications for Stratix V devices.

**Table 15. Hot Socketing Specifications for Stratix V Devices**

| Symbol                    | Description                                | Maximum             |
|---------------------------|--|---------------------|
| I <sub>IOPIN</sub> (DC)   | DC current per I/O pin                     | 300 $\mu$ A         |
| I <sub>IOPIN</sub> (AC)   | AC current per I/O pin                     | 8 mA <sup>(1)</sup> |
| I <sub>XCVR-TX</sub> (DC) | DC current per transceiver transmitter pin | 100 mA              |
| I <sub>XCVR-RX</sub> (DC) | DC current per transceiver receiver pin    | 50 mA               |

**Note to Table 15:**

(1) The I/O ramp rate is 10 ns or more. For ramp rates faster than 10 ns,  $|I_{IOPIN}| = C \, dv/dt$ , in which C is the I/O pin capacitance and dv/dt is the slew rate.

**Table 19. Single-Ended SSTL, HSTL, and HSUL I/O Standards Signal Specifications for Stratix V Devices (Part 2 of 2)**

| I/O Standard     | $V_{IL(DC)}$ (V) |                  | $V_{IH(DC)}$ (V) |                   | $V_{IL(AC)}$ (V) | $V_{IH(AC)}$ (V) | $V_{OL}$ (V)      | $V_{OH}$ (V)      | $I_{ol}$ (mA) | $I_{oh}$ (mA) |
|------------------|------------------|------------------|------------------|-------------------|------------------|------------------|-------------------|-------------------|---------------|---------------|
|                  | Min              | Max              | Min              | Max               | Max              | Min              | Max               | Min               |               |               |
| HSTL-18 Class I  | —                | $V_{REF} - 0.1$  | $V_{REF} + 0.1$  | —                 | $V_{REF} - 0.2$  | $V_{REF} + 0.2$  | 0.4               | $V_{CCIO} - 0.4$  | 8             | -8            |
| HSTL-18 Class II | —                | $V_{REF} - 0.1$  | $V_{REF} + 0.1$  | —                 | $V_{REF} - 0.2$  | $V_{REF} + 0.2$  | 0.4               | $V_{CCIO} - 0.4$  | 16            | -16           |
| HSTL-15 Class I  | —                | $V_{REF} - 0.1$  | $V_{REF} + 0.1$  | —                 | $V_{REF} - 0.2$  | $V_{REF} + 0.2$  | 0.4               | $V_{CCIO} - 0.4$  | 8             | -8            |
| HSTL-15 Class II | —                | $V_{REF} - 0.1$  | $V_{REF} + 0.1$  | —                 | $V_{REF} - 0.2$  | $V_{REF} + 0.2$  | 0.4               | $V_{CCIO} - 0.4$  | 16            | -16           |
| HSTL-12 Class I  | -0.15            | $V_{REF} - 0.08$ | $V_{REF} + 0.08$ | $V_{CCIO} + 0.15$ | $V_{REF} - 0.15$ | $V_{REF} + 0.15$ | $0.25^* V_{CCIO}$ | $0.75^* V_{CCIO}$ | 8             | -8            |
| HSTL-12 Class II | -0.15            | $V_{REF} - 0.08$ | $V_{REF} + 0.08$ | $V_{CCIO} + 0.15$ | $V_{REF} - 0.15$ | $V_{REF} + 0.15$ | $0.25^* V_{CCIO}$ | $0.75^* V_{CCIO}$ | 16            | -16           |
| HSUL-12          | —                | $V_{REF} - 0.13$ | $V_{REF} + 0.13$ | —                 | $V_{REF} - 0.22$ | $V_{REF} + 0.22$ | $0.1^* V_{CCIO}$  | $0.9^* V_{CCIO}$  | —             | —             |

**Table 20. Differential SSTL I/O Standards for Stratix V Devices**

| I/O Standard         | $V_{CCIO}$ (V) |      |       | $V_{SWING(DC)}$ (V) |                  | $V_{X(AC)}$ (V)      |              |                      | $V_{SWING(AC)}$ (V)       |                           |
|----------------------|----------------|------|-------|---------------------|------------------|----------------------|--------------|----------------------|---------------------------|---------------------------|
|                      | Min            | Typ  | Max   | Min                 | Max              | Min                  | Typ          | Max                  | Min                       | Max                       |
| SSTL-2 Class I, II   | 2.375          | 2.5  | 2.625 | 0.3                 | $V_{CCIO} + 0.6$ | $V_{CCIO}/2 - 0.2$   | —            | $V_{CCIO}/2 + 0.2$   | 0.62                      | $V_{CCIO} + 0.6$          |
| SSTL-18 Class I, II  | 1.71           | 1.8  | 1.89  | 0.25                | $V_{CCIO} + 0.6$ | $V_{CCIO}/2 - 0.175$ | —            | $V_{CCIO}/2 + 0.175$ | 0.5                       | $V_{CCIO} + 0.6$          |
| SSTL-15 Class I, II  | 1.425          | 1.5  | 1.575 | 0.2                 | (1)              | $V_{CCIO}/2 - 0.15$  | —            | $V_{CCIO}/2 + 0.15$  | 0.35                      | —                         |
| SSTL-135 Class I, II | 1.283          | 1.35 | 1.45  | 0.2                 | (1)              | $V_{CCIO}/2 - 0.15$  | $V_{CCIO}/2$ | $V_{CCIO}/2 + 0.15$  | $2(V_{IH(AC)} - V_{REF})$ | $2(V_{IL(AC)} - V_{REF})$ |
| SSTL-125 Class I, II | 1.19           | 1.25 | 1.31  | 0.18                | (1)              | $V_{CCIO}/2 - 0.15$  | $V_{CCIO}/2$ | $V_{CCIO}/2 + 0.15$  | $2(V_{IH(AC)} - V_{REF})$ | —                         |
| SSTL-12 Class I, II  | 1.14           | 1.2  | 1.26  | 0.18                | —                | $V_{REF} - 0.15$     | $V_{CCIO}/2$ | $V_{REF} + 0.15$     | -0.30                     | 0.30                      |

**Note to Table 20:**

- (1) The maximum value for  $V_{SWING(DC)}$  is not defined. However, each single-ended signal needs to be within the respective single-ended limits ( $V_{IH(DC)}$  and  $V_{IL(DC)}$ ).

**Table 21. Differential HSTL and HSUL I/O Standards for Stratix V Devices (Part 1 of 2)**

| I/O Standard        | $V_{CCIO}$ (V) |     |       | $V_{DIF(DC)}$ (V) |     | $V_{X(AC)}$ (V) |     |      | $V_{CM(DC)}$ (V) |     |      | $V_{DIF(AC)}$ (V) |     |
|---------------------|----------------|-----|-------|-------------------|-----|-----------------|-----|------|------------------|-----|------|-------------------|-----|
|                     | Min            | Typ | Max   | Min               | Max | Min             | Typ | Max  | Min              | Typ | Max  | Min               | Max |
| HSTL-18 Class I, II | 1.71           | 1.8 | 1.89  | 0.2               | —   | 0.78            | —   | 1.12 | 0.78             | —   | 1.12 | 0.4               | —   |
| HSTL-15 Class I, II | 1.425          | 1.5 | 1.575 | 0.2               | —   | 0.68            | —   | 0.9  | 0.68             | —   | 0.9  | 0.4               | —   |

## Switching Characteristics

This section provides performance characteristics of the Stratix V core and periphery blocks.

These characteristics can be designated as Preliminary or Final.

- Preliminary characteristics are created using simulation results, process data, and other known parameters. The title of these tables show the designation as “Preliminary.”
- Final numbers are based on actual silicon characterization and testing. The numbers reflect the actual performance of the device under worst-case silicon process, voltage, and junction temperature conditions. There are no designations on finalized tables.

## Transceiver Performance Specifications

This section describes transceiver performance specifications.

Table 23 lists the Stratix V GX and GS transceiver specifications.

**Table 23. Transceiver Specifications for Stratix V GX and GS Devices <sup>(1)</sup> (Part 1 of 7)**

| Symbol/<br>Description   | Conditions  | Transceiver Speed<br>Grade 1  |     |     | Transceiver Speed<br>Grade 2 |     |     | Transceiver Speed<br>Grade 3 |     |     | Unit |
|--|---|---|-----|-----|------------------------------|-----|-----|------------------------------|-----|-----|------|
|  |   | Min   | Typ | Max | Min                          | Typ | Max | Min                          | Typ | Max |      |
| Reference Clock  |   |   |     |     |                              |     |     |                              |     |     |      |
| Supported I/O<br>Standards                                     | Dedicated<br>reference<br>clock pin                               | 1.2-V PCML, 1.4-V PCML, 1.5-V PCML, 2.5-V PCML, Differential LVPECL, LVDS, and HCSL |     |     |                              |     |     |                              |     |     |      |
|  | RX reference<br>clock pin   | 1.4-V PCML, 1.5-V PCML, 2.5-V PCML, LVPECL, and LVDS                                |     |     |                              |     |     |                              |     |     |      |
| Input Reference<br>Clock Frequency<br>(CMU PLL) <sup>(8)</sup> | —   | 40  | —   | 710 | 40                           | —   | 710 | 40                           | —   | 710 | MHz  |
| Input Reference<br>Clock Frequency<br>(ATX PLL) <sup>(8)</sup> | —   | 100   | —   | 710 | 100                          | —   | 710 | 100                          | —   | 710 | MHz  |
| Rise time  | Measure at<br>±60 mV of<br>differential<br>signal <sup>(26)</sup> | —   | —   | 400 | —                            | —   | 400 | —                            | —   | 400 | ps   |
| Fall time  | Measure at<br>±60 mV of<br>differential<br>signal <sup>(26)</sup> | —   | —   | 400 | —                            | —   | 400 | —                            | —   | 400 |      |
| Duty cycle   | —   | 45  | —   | 55  | 45                           | —   | 55  | 45                           | —   | 55  | %    |
| Spread-spectrum<br>modulating clock<br>frequency               | PCI Express®<br>(PCIe®)   | 30  | —   | 33  | 30                           | —   | 33  | 30                           | —   | 33  | kHz  |

**Table 23. Transceiver Specifications for Stratix V GX and GS Devices <sup>(1)</sup> (Part 4 of 7)**

| Symbol/<br>Description                                     | Conditions  | Transceiver Speed<br>Grade 1 |           |     | Transceiver Speed<br>Grade 2 |           |     | Transceiver Speed<br>Grade 3 |           |     | Unit |
|--|---|------------------------------|-----------|-----|------------------------------|-----------|-----|------------------------------|-----------|-----|------|
|  |   | Min                          | Typ       | Max | Min                          | Typ       | Max | Min                          | Typ       | Max |      |
| Differential on-chip termination resistors <sup>(21)</sup> | 85-Ω setting  | —                            | 85 ± 30%  | —   | —                            | 85 ± 30%  | —   | —                            | 85 ± 30%  | —   | Ω    |
|  | 100-Ω setting   | —                            | 100 ± 30% | —   | —                            | 100 ± 30% | —   | —                            | 100 ± 30% | —   | Ω    |
|  | 120-Ω setting   | —                            | 120 ± 30% | —   | —                            | 120 ± 30% | —   | —                            | 120 ± 30% | —   | Ω    |
|  | 150-Ω setting   | —                            | 150 ± 30% | —   | —                            | 150 ± 30% | —   | —                            | 150 ± 30% | —   | Ω    |
| V <sub>ICM</sub><br>(AC and DC coupled)                    | V <sub>CCR_GXB</sub> = 0.85 V or 0.9 V full bandwidth   | —                            | 600       | —   | —                            | 600       | —   | —                            | 600       | —   | mV   |
|  | V <sub>CCR_GXB</sub> = 0.85 V or 0.9 V half bandwidth   | —                            | 600       | —   | —                            | 600       | —   | —                            | 600       | —   | mV   |
|  | V <sub>CCR_GXB</sub> = 1.0 V/1.05 V full bandwidth      | —                            | 700       | —   | —                            | 700       | —   | —                            | 700       | —   | mV   |
|  | V <sub>CCR_GXB</sub> = 1.0 V half bandwidth             | —                            | 750       | —   | —                            | 750       | —   | —                            | 750       | —   | mV   |
| t <sub>LTR</sub> <sup>(11)</sup>                           | —   | —                            | —         | 10  | —                            | —         | 10  | —                            | —         | 10  | μs   |
| t <sub>LTD</sub> <sup>(12)</sup>                           | —   | 4                            | —         | —   | 4                            | —         | —   | 4                            | —         | —   | μs   |
| t <sub>LTD_manual</sub> <sup>(13)</sup>                    | —   | 4                            | —         | —   | 4                            | —         | —   | 4                            | —         | —   | μs   |
| t <sub>LTR_LTD_manual</sub> <sup>(14)</sup>                | —   | 15                           | —         | —   | 15                           | —         | —   | 15                           | —         | —   | μs   |
| Run Length   | —   | —                            | —         | 200 | —                            | —         | 200 | —                            | —         | 200 | UI   |
| Programmable equalization (AC Gain) <sup>(10)</sup>        | Full bandwidth (6.25 GHz)<br>Half bandwidth (3.125 GHz) | —                            | —         | 16  | —                            | —         | 16  | —                            | —         | 16  | dB   |

Table 27 shows the  $V_{OD}$  settings for the GX channel.

**Table 27. Typical  $V_{OD}$  Setting for GX Channel, TX Termination = 100  $\Omega$  <sup>(2)</sup>**

| Symbol  | $V_{OD}$ Setting | $V_{OD}$ Value (mV) | $V_{OD}$ Setting | $V_{OD}$ Value (mV) |
|---|------------------|---------------------|------------------|---------------------|
| <b><math>V_{OD}</math> differential peak to peak typical <sup>(3)</sup></b> | 0 <sup>(1)</sup> | 0                   | 32               | 640                 |
|   | 1 <sup>(1)</sup> | 20                  | 33               | 660                 |
|   | 2 <sup>(1)</sup> | 40                  | 34               | 680                 |
|   | 3 <sup>(1)</sup> | 60                  | 35               | 700                 |
|   | 4 <sup>(1)</sup> | 80                  | 36               | 720                 |
|   | 5 <sup>(1)</sup> | 100                 | 37               | 740                 |
|   | 6                | 120                 | 38               | 760                 |
|   | 7                | 140                 | 39               | 780                 |
|   | 8                | 160                 | 40               | 800                 |
|   | 9                | 180                 | 41               | 820                 |
|   | 10               | 200                 | 42               | 840                 |
|   | 11               | 220                 | 43               | 860                 |
|   | 12               | 240                 | 44               | 880                 |
|   | 13               | 260                 | 45               | 900                 |
|   | 14               | 280                 | 46               | 920                 |
|   | 15               | 300                 | 47               | 940                 |
|   | 16               | 320                 | 48               | 960                 |
|   | 17               | 340                 | 49               | 980                 |
|   | 18               | 360                 | 50               | 1000                |
|   | 19               | 380                 | 51               | 1020                |
|   | 20               | 400                 | 52               | 1040                |
|   | 21               | 420                 | 53               | 1060                |
|   | 22               | 440                 | 54               | 1080                |
|   | 23               | 460                 | 55               | 1100                |
|   | 24               | 480                 | 56               | 1120                |
|   | 25               | 500                 | 57               | 1140                |
|   | 26               | 520                 | 58               | 1160                |
|   | 27               | 540                 | 59               | 1180                |
|   | 28               | 560                 | 60               | 1200                |
|   | 29               | 580                 | 61               | 1220                |
|   | 30               | 600                 | 62               | 1240                |
|   | 31               | 620                 | 63               | 1260                |

**Note to Table 27:**

- (1) If TX termination resistance = 100 $\Omega$ , this VOD setting is illegal.
- (2) The tolerance is +/-20% for all VOD settings except for settings 2 and below.
- (3) Refer to Figure 2.

**Table 28. Transceiver Specifications for Stratix V GT Devices (Part 2 of 5) <sup>(1)</sup>**

| Symbol/<br>Description  | Conditions  | Transceiver<br>Speed Grade 2                         |               |        | Transceiver<br>Speed Grade 3 |               |        | Unit     |
|---|---|--|---------------|--------|------------------------------|---------------|--------|----------|
|   |   | Min  | Typ           | Max    | Min                          | Typ           | Max    |          |
| Transmitter REFCLK<br>Phase Noise (622<br>MHz) <sup>(18)</sup>  | 100 Hz  | —  | —             | -70    | —                            | —             | -70    | dBc/Hz   |
|   | 1 kHz   | —  | —             | -90    | —                            | —             | -90    |          |
|   | 10 kHz  | —  | —             | -100   | —                            | —             | -100   |          |
|   | 100 kHz   | —  | —             | -110   | —                            | —             | -110   |          |
|   | ≥ 1 MHz   | —  | —             | -120   | —                            | —             | -120   |          |
| Transmitter REFCLK<br>Phase Jitter (100<br>MHz) <sup>(15)</sup>   | 10 kHz to<br>1.5 MHz<br>(PCIe)  | —  | —             | 3      | —                            | —             | 3      | ps (rms) |
| RREF <sup>(17)</sup>  | —   | —  | 1800<br>± 1%  | —      | —                            | 1800<br>± 1%  | —      | Ω        |
| <b>Transceiver Clocks</b>   |   |  |               |        |                              |               |        |          |
| fixedclk clock<br>frequency   | PCIe<br>Receiver<br>Detect  | —  | 100 or<br>125 | —      | —                            | 100 or<br>125 | —      | MHz      |
| Reconfiguration clock<br>(mgmt_clk_clk)<br>frequency  | —   | 100  | —             | 125    | 100                          | —             | 125    | MHz      |
| <b>Receiver</b>   |   |  |               |        |                              |               |        |          |
| Supported I/O<br>Standards  | —   | 1.4-V PCML, 1.5-V PCML, 2.5-V PCML, LVPECL, and LVDS |               |        |                              |               |        |          |
| Data rate<br>(Standard PCS) <sup>(21)</sup>   | GX channels   | 600  | —             | 8500   | 600                          | —             | 8500   | Mbps     |
| Data rate<br>(10G PCS) <sup>(21)</sup>  | GX channels   | 600  | —             | 12,500 | 600                          | —             | 12,500 | Mbps     |
| Data rate   | GT channels   | 19,600   | —             | 28,050 | 19,600                       | —             | 25,780 | Mbps     |
| Absolute V <sub>MAX</sub> for a<br>receiver pin <sup>(3)</sup>  | GT channels   | —  | —             | 1.2    | —                            | —             | 1.2    | V        |
| Absolute V <sub>MIN</sub> for a<br>receiver pin   | GT channels   | -0.4   | —             | —      | -0.4                         | —             | —      | V        |
| Maximum peak-to-peak<br>differential input<br>voltage V <sub>ID</sub> (diff p-p)<br>before device<br>configuration <sup>(20)</sup>                  | GT channels   | —  | —             | 1.6    | —                            | —             | 1.6    | V        |
|   | GX channels   | <sup>(8)</sup>                                       |               |        |                              |               |        |          |
| Maximum peak-to-peak<br>differential input<br>voltage V <sub>ID</sub> (diff p-p)<br>after device<br>configuration <sup>(16)</sup> , <sup>(20)</sup> | GT channels<br>V <sub>CCR_GTB</sub> =<br>1.05 V<br>(V <sub>ICM</sub> =<br>0.65 V) | —  | —             | 2.2    | —                            | —             | 2.2    | V        |
|   | GX channels   | <sup>(8)</sup>                                       |               |        |                              |               |        |          |
| Minimum differential<br>eye opening at receiver<br>serial input pins <sup>(4)</sup> , <sup>(20)</sup>   | GT channels   | 200  | —             | —      | 200                          | —             | —      | mV       |
|   | GX channels   | <sup>(8)</sup>                                       |               |        |                              |               |        |          |

**Table 28. Transceiver Specifications for Stratix V GT Devices (Part 3 of 5) <sup>(1)</sup>**

| Symbol/<br>Description   | Conditions                      | Transceiver<br>Speed Grade 2 |               |        | Transceiver<br>Speed Grade 3 |               |        | Unit      |
|--|---------------------------------|------------------------------|---------------|--------|------------------------------|---------------|--------|-----------|
|  |                                 | Min                          | Typ           | Max    | Min                          | Typ           | Max    |           |
| Differential on-chip termination resistors <sup>(7)</sup>                  | GT channels                     | —                            | 100           | —      | —                            | 100           | —      | $\Omega$  |
| Differential on-chip termination resistors for GX channels <sup>(19)</sup> | 85- $\Omega$ setting            | —                            | 85 $\pm$ 30%  | —      | —                            | 85 $\pm$ 30%  | —      | $\Omega$  |
|  | 100- $\Omega$ setting           | —                            | 100 $\pm$ 30% | —      | —                            | 100 $\pm$ 30% | —      | $\Omega$  |
|  | 120- $\Omega$ setting           | —                            | 120 $\pm$ 30% | —      | —                            | 120 $\pm$ 30% | —      | $\Omega$  |
|  | 150- $\Omega$ setting           | —                            | 150 $\pm$ 30% | —      | —                            | 150 $\pm$ 30% | —      | $\Omega$  |
| V <sub>ICM</sub> (AC coupled)  | GT channels                     | —                            | 650           | —      | —                            | 650           | —      | mV        |
| VICM (AC and DC coupled) for GX Channels                                   | VCCR_GXB = 0.85 V or 0.9 V      | —                            | 600           | —      | —                            | 600           | —      | mV        |
|  | VCCR_GXB = 1.0 V full bandwidth | —                            | 700           | —      | —                            | 700           | —      | mV        |
|  | VCCR_GXB = 1.0 V half bandwidth | —                            | 750           | —      | —                            | 750           | —      | mV        |
| t <sub>LTR</sub> <sup>(9)</sup>  | —                               | —                            | —             | 10     | —                            | —             | 10     | $\mu$ s   |
| t <sub>LTD</sub> <sup>(10)</sup>   | —                               | 4                            | —             | —      | 4                            | —             | —      | $\mu$ s   |
| t <sub>LTD_manual</sub> <sup>(11)</sup>                                    | —                               | 4                            | —             | —      | 4                            | —             | —      | $\mu$ s   |
| t <sub>LTR_LTD_manual</sub> <sup>(12)</sup>                                | —                               | 15                           | —             | —      | 15                           | —             | —      | $\mu$ s   |
| Run Length   | GT channels                     | —                            | —             | 72     | —                            | —             | 72     | CID       |
|  | GX channels                     | <sup>(8)</sup>               |               |        |                              |               |        |           |
| CDR PPM  | GT channels                     | —                            | —             | 1000   | —                            | —             | 1000   | $\pm$ PPM |
|  | GX channels                     | <sup>(8)</sup>               |               |        |                              |               |        |           |
| Programmable equalization (AC Gain) <sup>(5)</sup>                         | GT channels                     | —                            | —             | 14     | —                            | —             | 14     | dB        |
|  | GX channels                     | <sup>(8)</sup>               |               |        |                              |               |        |           |
| Programmable DC gain <sup>(6)</sup>  | GT channels                     | —                            | —             | 7.5    | —                            | —             | 7.5    | dB        |
|  | GX channels                     | <sup>(8)</sup>               |               |        |                              |               |        |           |
| Differential on-chip termination resistors <sup>(7)</sup>                  | GT channels                     | —                            | 100           | —      | —                            | 100           | —      | $\Omega$  |
| <b>Transmitter</b>   |                                 |                              |               |        |                              |               |        |           |
| Supported I/O Standards  | —                               | 1.4-V and 1.5-V PCML         |               |        |                              |               |        |           |
| Data rate (Standard PCS)   | GX channels                     | 600                          | —             | 8500   | 600                          | —             | 8500   | Mbps      |
| Data rate (10G PCS)  | GX channels                     | 600                          | —             | 12,500 | 600                          | —             | 12,500 | Mbps      |



**Table 28. Transceiver Specifications for Stratix V GT Devices (Part 4 of 5) <sup>(1)</sup>**

| Symbol/<br>Description   | Conditions                                   | Transceiver<br>Speed Grade 2 |     |                                | Transceiver<br>Speed Grade 3 |     |                                | Unit |
|--|--|------------------------------|-----|--------------------------------|------------------------------|-----|--------------------------------|------|
|  |  | Min                          | Typ | Max                            | Min                          | Typ | Max                            |      |
| Data rate  | GT channels                                  | 19,600                       | —   | 28,050                         | 19,600                       | —   | 25,780                         | Mbps |
| Differential on-chip<br>termination resistors                      | GT channels                                  | —                            | 100 | —                              | —                            | 100 | —                              | Ω    |
|  | GX channels                                  | (8)                          |     |                                |                              |     |                                |      |
| V <sub>OCM</sub> (AC coupled)                                      | GT channels                                  | —                            | 500 | —                              | —                            | 500 | —                              | mV   |
|  | GX channels                                  | (8)                          |     |                                |                              |     |                                |      |
| Rise/Fall time   | GT channels                                  | —                            | 15  | —                              | —                            | 15  | —                              | ps   |
|  | GX channels                                  | (8)                          |     |                                |                              |     |                                |      |
| Intra-differential pair<br>skew                                    | GX channels                                  | (8)                          |     |                                |                              |     |                                |      |
| Intra-transceiver block<br>transmitter channel-to-<br>channel skew | GX channels                                  | (8)                          |     |                                |                              |     |                                |      |
| Inter-transceiver block<br>transmitter channel-to-<br>channel skew | GX channels                                  | (8)                          |     |                                |                              |     |                                |      |
| CMU PLL  |  |                              |     |                                |                              |     |                                |      |
| Supported Data Range   | —  | 600                          | —   | 12500                          | 600                          | —   | 8500                           | Mbps |
| t <sub>pll_powerdown</sub> <sup>(13)</sup>                         | —  | 1                            | —   | —                              | 1                            | —   | —                              | μs   |
| t <sub>pll_lock</sub> <sup>(14)</sup>                              | —  | —                            | —   | 10                             | —                            | —   | 10                             | μs   |
| ATX PLL  |  |                              |     |                                |                              |     |                                |      |
| Supported Data Rate<br>Range for GX Channels                       | VCO post-<br>divider L=2                     | 8000                         | —   | 12500                          | 8000                         | —   | 8500                           | Mbps |
|  | L=4  | 4000                         | —   | 6600                           | 4000                         | —   | 6600                           | Mbps |
|  | L=8  | 2000                         | —   | 3300                           | 2000                         | —   | 3300                           | Mbps |
|  | L=8,<br>Local/Central<br>Clock Divider<br>=2 | 1000                         | —   | 1762.5                         | 1000                         | —   | 1762.5                         | Mbps |
| Supported Data Rate<br>Range for GT Channels                       | VCO post-<br>divider L=2                     | 9800                         | —   | 14025                          | 9800                         | —   | 12890                          | Mbps |
| t <sub>pll_powerdown</sub> <sup>(13)</sup>                         | —  | 1                            | —   | —                              | 1                            | —   | —                              | μs   |
| t <sub>pll_lock</sub> <sup>(14)</sup>                              | —  | —                            | —   | 10                             | —                            | —   | 10                             | μs   |
| fPLL   |  |                              |     |                                |                              |     |                                |      |
| Supported Data Range   | —  | 600                          | —   | 3250/<br>3.125 <sup>(23)</sup> | 600                          | —   | 3250/<br>3.125 <sup>(23)</sup> | Mbps |
| t <sub>pll_powerdown</sub> <sup>(13)</sup>                         | —  | 1                            | —   | —                              | 1                            | —   | —                              | μs   |

Table 29 shows the  $V_{OD}$  settings for the GT channel.

**Table 29. Typical  $V_{OD}$  Setting for GT Channel, TX Termination = 100  $\Omega$**

| Symbol  | $V_{OD}$ Setting | $V_{OD}$ Value (mV) |
|---|------------------|---------------------|
| <b><math>V_{OD}</math> differential peak to peak typical <sup>(1)</sup></b> | 0                | 0                   |
|   | 1                | 200                 |
|   | 2                | 400                 |
|   | 3                | 600                 |
|   | 4                | 800                 |
|   | 5                | 1000                |

**Note:**

(1) Refer to Figure 4.

Figure 4 shows the differential transmitter output waveform.

**Figure 4. Differential Transmitter/Receiver Output/Input Waveform**



Figure 5 shows the Stratix V AC gain curves for GT channels.

**Figure 5. AC Gain Curves for GT Channels**

**Table 33. Memory Block Performance Specifications for Stratix V Devices <sup>(1), (2)</sup> (Part 2 of 2)**

| Memory     | Mode   | Resources Used |        | Performance |         |     |     |         |               |     | Unit |
|------------|--|----------------|--------|-------------|---------|-----|-----|---------|---------------|-----|------|
|            |  | ALUTs          | Memory | C1          | C2, C2L | C3  | C4  | I2, I2L | I3, I3L, I3YY | I4  |      |
| M20K Block | Single-port, all supported widths  | 0              | 1      | 700         | 700     | 650 | 550 | 700     | 500           | 450 | MHz  |
|            | Simple dual-port, all supported widths   | 0              | 1      | 700         | 700     | 650 | 550 | 700     | 500           | 450 | MHz  |
|            | Simple dual-port with the read-during-write option set to <b>Old Data</b> , all supported widths | 0              | 1      | 525         | 525     | 455 | 400 | 525     | 455           | 400 | MHz  |
|            | Simple dual-port with ECC enabled, 512 × 32  | 0              | 1      | 450         | 450     | 400 | 350 | 450     | 400           | 350 | MHz  |
|            | Simple dual-port with ECC and optional pipeline registers enabled, 512 × 32                      | 0              | 1      | 600         | 600     | 500 | 450 | 600     | 500           | 450 | MHz  |
|            | True dual port, all supported widths   | 0              | 1      | 700         | 700     | 650 | 550 | 700     | 500           | 450 | MHz  |
|            | ROM, all supported widths  | 0              | 1      | 700         | 700     | 650 | 550 | 700     | 500           | 450 | MHz  |

**Notes to Table 33:**

- (1) To achieve the maximum memory block performance, use a memory block clock that comes through global clock routing from an on-chip PLL set to **50%** output duty cycle. Use the Quartus II software to report timing for this and other memory block clocking schemes.
- (2) When you use the error detection cyclical redundancy check (CRC) feature, there is no degradation in F<sub>MAX</sub>.
- (3) The F<sub>MAX</sub> specification is only achievable with Fitter options, **MLAB Implementation In 16-Bit Deep Mode** enabled.

**Temperature Sensing Diode Specifications**

Table 34 lists the internal TSD specification.

**Table 34. Internal Temperature Sensing Diode Specification**

| Temperature Range | Accuracy | Offset Calibrated Option | Sampling Rate  | Conversion Time | Resolution | Minimum Resolution with no Missing Codes |
|-------------------|----------|--------------------------|----------------|-----------------|------------|--|
| –40°C to 100°C    | ±8°C     | No                       | 1 MHz, 500 KHz | < 100 ms        | 8 bits     | 8 bits                                   |

Table 35 lists the specifications for the Stratix V external temperature sensing diode.

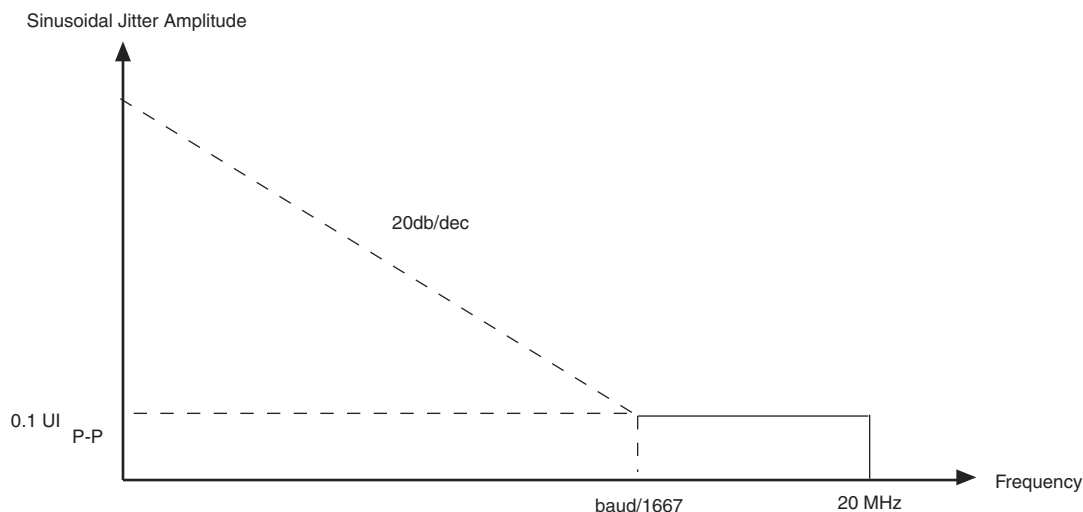
**Table 35. External Temperature Sensing Diode Specifications for Stratix V Devices**

| Description                              | Min   | Typ   | Max   | Unit |
|--|-------|-------|-------|------|
| I <sub>bias</sub> , diode source current | 8     | —     | 200   | μA   |
| V <sub>bias</sub> , voltage across diode | 0.3   | —     | 0.9   | V    |
| Series resistance                        | —     | —     | < 1   | Ω    |
| Diode ideality factor                    | 1.006 | 1.008 | 1.010 | —    |

**Table 38. LVDS Soft-CDR/DPA Sinusoidal Jitter Mask Values for a Data Rate  $\geq 1.25$  Gbps**

| Jitter Frequency (Hz) |            | Sinusoidal Jitter (UI) |
|-----------------------|------------|------------------------|
| F1                    | 10,000     | 25.000                 |
| F2                    | 17,565     | 25.000                 |
| F3                    | 1,493,000  | 0.350                  |
| F4                    | 50,000,000 | 0.350                  |

Figure 9 shows the LVDS soft-CDR/DPA sinusoidal jitter tolerance specification for a data rate  $< 1.25$  Gbps.

**Figure 9. LVDS Soft-CDR/DPA Sinusoidal Jitter Tolerance Specification for a Data Rate  $< 1.25$  Gbps**

### DLL Range, DQS Logic Block, and Memory Output Clock Jitter Specifications

Table 39 lists the DLL range specification for Stratix V devices. The DLL is always in 8-tap mode in Stratix V devices.

**Table 39. DLL Range Specifications for Stratix V Devices <sup>(1)</sup>**

| C1      | C2, C2L, I2, I2L | C3, I3, I3L, I3YY | C4,I4   | Unit |
|---------|------------------|-------------------|---------|------|
| 300-933 | 300-933          | 300-890           | 300-890 | MHz  |

**Note to Table 39:**

- (1) Stratix V devices support memory interface frequencies lower than 300 MHz, although the reference clock that feeds the DLL must be at least 300 MHz. To support interfaces below 300 MHz, multiply the reference clock feeding the DLL to ensure the frequency is within the supported range of the DLL.

Table 40 lists the DQS phase offset delay per stage for Stratix V devices.

**Table 40. DQS Phase Offset Delay Per Setting for Stratix V Devices <sup>(1), (2)</sup> (Part 1 of 2)**

| Speed Grade      | Min | Max | Unit |
|------------------|-----|-----|------|
| C1               | 8   | 14  | ps   |
| C2, C2L, I2, I2L | 8   | 14  | ps   |
| C3,I3, I3L, I3YY | 8   | 15  | ps   |

**Table 40. DQS Phase Offset Delay Per Setting for Stratix V Devices <sup>(1), (2)</sup> (Part 2 of 2)**

| Speed Grade | Min | Max | Unit |
|-------------|-----|-----|------|
| C4,I4       | 8   | 16  | ps   |

**Notes to Table 40:**

- (1) The typical value equals the average of the minimum and maximum values.
- (2) The delay settings are linear with a cumulative delay variation of 40 ps for all speed grades. For example, when using a –2 speed grade and applying a 10-phase offset setting to a 90° phase shift at 400 MHz, the expected average cumulative delay is  $[625 \text{ ps} + (10 \times 10 \text{ ps}) \pm 20 \text{ ps}] = 725 \text{ ps} \pm 20 \text{ ps}$ .

Table 41 lists the DQS phase shift error for Stratix V devices.

**Table 41. DQS Phase Shift Error Specification for DLL-Delayed Clock ( $t_{\text{DQS\_PSERR}}$ ) for Stratix V Devices <sup>(1)</sup>**

| Number of DQS Delay Buffers | C1  | C2, C2L, I2, I2L | C3, I3, I3L, I3YY | C4,I4 | Unit |
|-----------------------------|-----|------------------|-------------------|-------|------|
| 1                           | 28  | 28               | 30                | 32    | ps   |
| 2                           | 56  | 56               | 60                | 64    | ps   |
| 3                           | 84  | 84               | 90                | 96    | ps   |
| 4                           | 112 | 112              | 120               | 128   | ps   |

**Notes to Table 41:**

- (1) This error specification is the absolute maximum and minimum error. For example, skew on three DQS delay buffers in a –2 speed grade is  $\pm 78 \text{ ps}$  or  $\pm 39 \text{ ps}$ .

Table 42 lists the memory output clock jitter specifications for Stratix V devices.

**Table 42. Memory Output Clock Jitter Specification for Stratix V Devices <sup>(1), (Part 1 of 2)</sup> <sup>(2), (3)</sup>**

| Clock Network | Parameter                    | Symbol                 | C1   |     | C2, C2L, I2, I2L |     | C3, I3, I3L, I3YY |      | C4,I4 |      | Unit |
|---------------|------------------------------|------------------------|------|-----|------------------|-----|-------------------|------|-------|------|------|
|               |                              |                        | Min  | Max | Min              | Max | Min               | Max  | Min   | Max  |      |
| Regional      | Clock period jitter          | $t_{\text{JIT(per)}}$  | –50  | 50  | –50              | 50  | –55               | 55   | –55   | 55   | ps   |
|               | Cycle-to-cycle period jitter | $t_{\text{JIT(cc)}}$   | –100 | 100 | –100             | 100 | –110              | 110  | –110  | 110  | ps   |
|               | Duty cycle jitter            | $t_{\text{JIT(duty)}}$ | –50  | 50  | –50              | 50  | –82.5             | 82.5 | –82.5 | 82.5 | ps   |
| Global        | Clock period jitter          | $t_{\text{JIT(per)}}$  | –75  | 75  | –75              | 75  | –82.5             | 82.5 | –82.5 | 82.5 | ps   |
|               | Cycle-to-cycle period jitter | $t_{\text{JIT(cc)}}$   | –150 | 150 | –150             | 150 | –165              | 165  | –165  | 165  | ps   |
|               | Duty cycle jitter            | $t_{\text{JIT(duty)}}$ | –75  | 75  | –75              | 75  | –90               | 90   | –90   | 90   | ps   |

**Table 42. Memory Output Clock Jitter Specification for Stratix V Devices <sup>(1)</sup>, (Part 2 of 2) <sup>(2)</sup>, <sup>(3)</sup>**

| Clock Network | Parameter                    | Symbol          | C1    |      | C2, C2L, I2, I2L |      | C3, I3, I3L, I3YY |     | C4,I4 |     | Unit |
|---------------|------------------------------|-----------------|-------|------|------------------|------|-------------------|-----|-------|-----|------|
|               |                              |                 | Min   | Max  | Min              | Max  | Min               | Max | Min   | Max |      |
| PHY Clock     | Clock period jitter          | $t_{JIT(per)}$  | -25   | 25   | -25              | 25   | -30               | 30  | -35   | 35  | ps   |
|               | Cycle-to-cycle period jitter | $t_{JIT(cc)}$   | -50   | 50   | -50              | 50   | -60               | 60  | -70   | 70  | ps   |
|               | Duty cycle jitter            | $t_{JIT(duty)}$ | -37.5 | 37.5 | -37.5            | 37.5 | -45               | 45  | -56   | 56  | ps   |

**Notes to Table 42:**

- (1) The clock jitter specification applies to the memory output clock pins generated using differential signal-splitter and DDIO circuits clocked by a PLL output routed on a PHY, regional, or global clock network as specified. Altera recommends using PHY clock networks whenever possible.
- (2) The clock jitter specification applies to the memory output clock pins clocked by an integer PLL.
- (3) The memory output clock jitter is applicable when an input jitter of 30 ps peak-to-peak is applied with bit error rate (BER) -12, equivalent to 14 sigma.

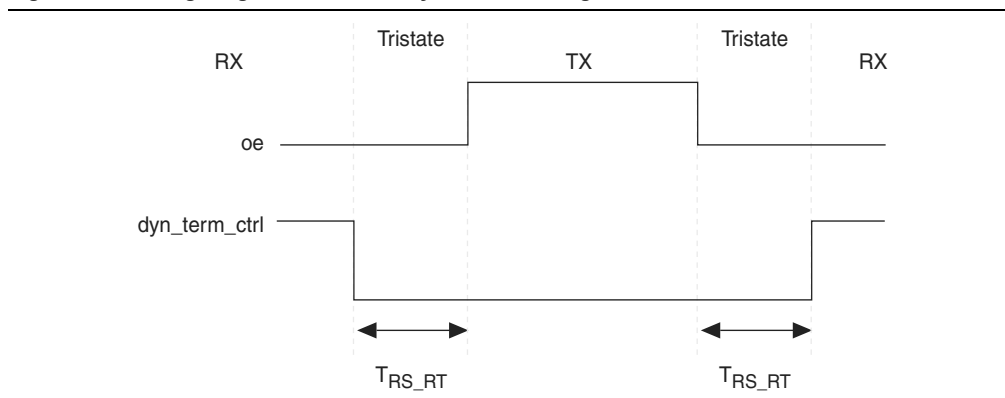
**OCT Calibration Block Specifications**

Table 43 lists the OCT calibration block specifications for Stratix V devices.

**Table 43. OCT Calibration Block Specifications for Stratix V Devices**

| Symbol         | Description   | Min | Typ  | Max | Unit   |
|----------------|---|-----|------|-----|--------|
| OCTUSRCLK      | Clock required by the OCT calibration blocks  | —   | —    | 20  | MHz    |
| $T_{OCTCAL}$   | Number of OCTUSRCLK clock cycles required for OCT $R_S/R_T$ calibration   | —   | 1000 | —   | Cycles |
| $T_{OCTSHIFT}$ | Number of OCTUSRCLK clock cycles required for the OCT code to shift out   | —   | 32   | —   | Cycles |
| $T_{RS\_RT}$   | Time required between the <code>dyn_term_ctrl</code> and <code>oe</code> signal transitions in a bidirectional I/O buffer to dynamically switch between OCT $R_S$ and $R_T$ (Figure 10) | —   | 2.5  | —   | ns     |

Figure 10 shows the timing diagram for the `oe` and `dyn_term_ctrl` signals.

**Figure 10. Timing Diagram for `oe` and `dyn_term_ctrl` Signals**

**Figure 13. FPP Configuration Timing Waveform When the DCLK-to-DATA[] Ratio is >1 (1), (2)****Notes to Figure 13:**

- (1) Use this timing waveform and parameters when the DCLK-to-DATA[] ratio is >1. To find out the DCLK-to-DATA[] ratio for your system, refer to Table 49 on page 55.
- (2) The beginning of this waveform shows the device in user mode. In user mode, nCONFIG, nSTATUS, and CONF\_DONE are at logic high levels. When nCONFIG is pulled low, a reconfiguration cycle begins.
- (3) After power-up, the Stratix V device holds nSTATUS low for the time as specified by the POR delay.
- (4) After power-up, before and during configuration, CONF\_DONE is low.
- (5) Do not leave DCLK floating after configuration. You can drive it high or low, whichever is more convenient.
- (6) "r" denotes the DCLK-to-DATA[] ratio. For the DCLK-to-DATA[] ratio based on the decompression and the design security feature enable settings, refer to Table 49 on page 55.
- (7) If needed, pause DCLK by holding it low. When DCLK restarts, the external host must provide data on the DATA[31..0] pins prior to sending the first DCLK rising edge.
- (8) To ensure a successful configuration, send the entire configuration data to the Stratix V device. CONF\_DONE is released high after the Stratix V device receives all the configuration data successfully. After CONF\_DONE goes high, send two additional falling edges on DCLK to begin initialization and enter user mode.
- (9) After the option bit to enable the INIT\_DONE pin is configured into the device, the INIT\_DONE goes low.



## Active Serial Configuration Timing

Table 52 lists the DCLK frequency specification in the AS configuration scheme.

**Table 52. DCLK Frequency Specification in the AS Configuration Scheme <sup>(1), (2)</sup>**

| Minimum | Typical | Maximum | Unit |
|---------|---------|---------|------|
| 5.3     | 7.9     | 12.5    | MHz  |
| 10.6    | 15.7    | 25.0    | MHz  |
| 21.3    | 31.4    | 50.0    | MHz  |
| 42.6    | 62.9    | 100.0   | MHz  |

**Notes to Table 52:**

- (1) This applies to the DCLK frequency specification when using the internal oscillator as the configuration clock source.
- (2) The AS multi-device configuration scheme does not support DCLK frequency of 100 MHz.

Figure 14 shows the single-device configuration setup for an AS ×1 mode.

**Figure 14. AS Configuration Timing**



**Notes to Figure 14:**

- (1) If you are using AS ×4 mode, this signal represents the AS\_DATA [3 : 0] and EPCQ sends in 4-bits of data for each DCLK cycle.
- (2) The initialization clock can be from internal oscillator or CLKUSR pin.
- (3) After the option bit to enable the INIT\_DONE pin is configured into the device, the INIT\_DONE goes low.

Table 53 lists the timing parameters for AS ×1 and AS ×4 configurations in Stratix V devices.

**Table 53. AS Timing Parameters for AS ×1 and AS ×4 Configurations in Stratix V Devices <sup>(1), (2)</sup> (Part 1 of 2)**

| Symbol   | Parameter                                   | Minimum | Maximum | Units |
|----------|---|---------|---------|-------|
| $t_{CO}$ | DCLK falling edge to AS_DATA0/ASDO output   | —       | 2       | ns    |
| $t_{SU}$ | Data setup time before falling edge on DCLK | 1.5     | —       | ns    |
| $t_H$    | Data hold time after falling edge on DCLK   | 0       | —       | ns    |

Table 60. Glossary (Part 3 of 4)

| Letter | Subject                                      | Definitions  |
|--------|--|--|
| S      | SW (sampling window)                         | <p>Timing Diagram—the period of time during which the data must be valid in order to capture it correctly. The setup and hold times determine the ideal strobe position within the sampling window, as shown:</p>    |
|        | Single-ended voltage referenced I/O standard | <p>The JEDEC standard for <b>SSTL</b> and <b>HSTL</b> I/O defines both the AC and DC input signal values. The AC values indicate the voltage levels at which the receiver must meet its timing specifications. The DC values indicate the voltage levels at which the final logic state of the receiver is unambiguously defined. After the receiver input has crossed the AC value, the receiver changes to the new logic state.</p> <p>The new logic state is then maintained as long as the input stays beyond the DC threshold. This approach is intended to provide predictable receiver timing in the presence of input waveform ringing:</p> <p><i>Single-Ended Voltage Referenced I/O Standard</i></p>  |
| T      | $t_c$  | High-speed receiver and transmitter input and output clock period.   |
|        | TCCS (channel-to-channel-skew)               | The timing difference between the fastest and slowest output edges, including $t_{CO}$ variation and clock skew, across channels driven by the same PLL. The clock is included in the TCCS measurement (refer to the <i>Timing Diagram</i> figure under <b>SW</b> in this table).  |
|        | $t_{DUTY}$                                   | <p>High-speed I/O block—Duty cycle on the high-speed transmitter output clock.</p> <p><b>Timing Unit Interval (TUI)</b></p> <p>The timing budget allowed for skew, propagation delays, and the data sampling window. (TUI = <math>1/(\text{receiver input clock frequency multiplication factor}) = t_c/w</math>)</p>  |
|        | $t_{FALL}$                                   | Signal high-to-low transition time (80-20%)  |
|        | $t_{INCCJ}$                                  | Cycle-to-cycle jitter tolerance on the PLL clock input.  |
|        | $t_{OUTPJ\_IO}$                              | Period jitter on the general purpose I/O driven by a PLL.  |
|        | $t_{OUTPJ\_DC}$                              | Period jitter on the dedicated clock output driven by a PLL.   |
|        | $t_{RISE}$                                   | Signal low-to-high transition time (20-80%)  |
| U      | —  | —  |

**Table 60. Glossary (Part 4 of 4)**

| Letter   | Subject       | Definitions  |
|----------|---------------|--|
| <b>V</b> | $V_{CM(DC)}$  | DC common mode input voltage.  |
|          | $V_{ICM}$     | Input common mode voltage—The common mode of the differential signal at the receiver.  |
|          | $V_{ID}$      | Input differential voltage swing—The difference in voltage between the positive and complementary conductors of a differential transmission at the receiver.     |
|          | $V_{DIF(AC)}$ | AC differential input voltage—Minimum AC input differential voltage required for switching.  |
|          | $V_{DIF(DC)}$ | DC differential input voltage— Minimum DC input differential voltage required for switching.   |
|          | $V_{IH}$      | Voltage input high—The minimum positive voltage applied to the input which is accepted by the device as a logic high.  |
|          | $V_{IH(AC)}$  | High-level AC input voltage  |
|          | $V_{IH(DC)}$  | High-level DC input voltage  |
|          | $V_{IL}$      | Voltage input low—The maximum positive voltage applied to the input which is accepted by the device as a logic low.  |
|          | $V_{IL(AC)}$  | Low-level AC input voltage   |
|          | $V_{IL(DC)}$  | Low-level DC input voltage   |
|          | $V_{OCM}$     | Output common mode voltage—The common mode of the differential signal at the transmitter.  |
|          | $V_{OD}$      | Output differential voltage swing—The difference in voltage between the positive and complementary conductors of a differential transmission at the transmitter. |
|          | $V_{SWING}$   | Differential input voltage   |
|          | $V_X$         | Input differential cross point voltage   |
|          | $V_{OX}$      | Output differential cross point voltage  |
| <b>W</b> | W             | High-speed I/O block—clock boost factor  |
| <b>X</b> | —             | —  |
| <b>Y</b> |               |  |
| <b>Z</b> |               |  |

**Table 61. Document Revision History (Part 2 of 3)**

| Date          | Version | Changes  |
|---------------|---------|--|
| November 2014 | 3.3     | <ul style="list-style-type: none"> <li>■ Added the I3YY speed grade and changed the data rates for the GX channel in Table 1.</li> <li>■ Added the I3YY speed grade to the <math>V_{CC}</math> description in Table 6.</li> <li>■ Added the I3YY speed grade to <math>V_{CCHIP\_L}</math>, <math>V_{CCHIP\_R}</math>, <math>V_{CCHSSI\_L}</math>, and <math>V_{CCHSSI\_R}</math> descriptions in Table 7.</li> <li>■ Added 240-<math>\Omega</math> to Table 11.</li> <li>■ Changed CDR PPM tolerance in Table 23.</li> <li>■ Added additional max data rate for fPLL in Table 23.</li> <li>■ Added the I3YY speed grade and changed the data rates for transceiver speed grade 3 in Table 25.</li> <li>■ Added the I3YY speed grade and changed the data rates for transceiver speed grade 3 in Table 26.</li> <li>■ Changed CDR PPM tolerance in Table 28.</li> <li>■ Added additional max data rate for fPLL in Table 28.</li> <li>■ Changed the mode descriptions for MLAB and M20K in Table 33.</li> <li>■ Changed the Max value of <math>f_{HCLK\_OUT}</math> for the C2, C2L, I2, I2L speed grades in Table 36.</li> <li>■ Changed the frequency ranges for C1 and C2 in Table 39.</li> <li>■ Changed the .rbf file sizes for 5SGSD6 and 5SGSD8 in Table 47.</li> <li>■ Added note about nSTATUS to Table 50, Table 51, Table 54.</li> <li>■ Changed the available settings in Table 58.</li> <li>■ Changed the note in “Periphery Performance”.</li> <li>■ Updated the “I/O Standard Specifications” section.</li> <li>■ Updated the “Raw Binary File Size” section.</li> <li>■ Updated the receiver voltage input range in Table 22.</li> <li>■ Updated the max frequency for the LVDS clock network in Table 36.</li> <li>■ Updated the DCLK note to Figure 11.</li> <li>■ Updated Table 23 <math>VO_{CM}</math> (DC Coupled) condition.</li> <li>■ Updated Table 6 and Table 7.</li> <li>■ Added the DCLK specification to Table 55.</li> <li>■ Updated the notes for Table 47.</li> <li>■ Updated the list of parameters for Table 56.</li> </ul> |
| November 2013 | 3.2     | ■ Updated Table 28   |
| November 2013 | 3.1     | ■ Updated Table 33   |
| November 2013 | 3.0     | ■ Updated Table 23 and Table 28  |
| October 2013  | 2.9     | ■ Updated the “Transceiver Characterization” section   |
| October 2013  | 2.8     | <ul style="list-style-type: none"> <li>■ Updated Table 3, Table 12, Table 14, Table 19, Table 20, Table 23, Table 24, Table 28, Table 30, Table 31, Table 32, Table 33, Table 36, Table 39, Table 40, Table 41, Table 42, Table 47, Table 53, Table 58, and Table 59</li> <li>■ Added Figure 1 and Figure 3</li> <li>■ Added the “Transceiver Characterization” section</li> <li>■ Removed all “Preliminary” designations.</li> </ul>  |

**Table 61. Document Revision History (Part 3 of 3)**

| Date          | Version | Changes  |
|---------------|---------|--|
| May 2013      | 2.7     | <ul style="list-style-type: none"> <li>■ Updated Table 2, Table 6, Table 7, Table 20, Table 23, Table 27, Table 47, Table 60</li> <li>■ Added Table 24, Table 48</li> <li>■ Updated Figure 9, Figure 10, Figure 11, Figure 12</li> </ul>   |
| February 2013 | 2.6     | <ul style="list-style-type: none"> <li>■ Updated Table 7, Table 9, Table 20, Table 23, Table 27, Table 30, Table 31, Table 35, Table 46</li> <li>■ Updated “Maximum Allowed Overshoot and Undershoot Voltage”</li> </ul>   |
| December 2012 | 2.5     | <ul style="list-style-type: none"> <li>■ Updated Table 3, Table 6, Table 7, Table 8, Table 23, Table 24, Table 25, Table 27, Table 30, Table 32, Table 35</li> <li>■ Added Table 33</li> <li>■ Added “Fast Passive Parallel Configuration Timing”</li> <li>■ Added “Active Serial Configuration Timing”</li> <li>■ Added “Passive Serial Configuration Timing”</li> <li>■ Added “Remote System Upgrades”</li> <li>■ Added “User Watchdog Internal Circuitry Timing Specification”</li> <li>■ Added “Initialization”</li> <li>■ Added “Raw Binary File Size”</li> </ul> |
| June 2012     | 2.4     | <ul style="list-style-type: none"> <li>■ Added Figure 1, Figure 2, and Figure 3.</li> <li>■ Updated Table 1, Table 2, Table 3, Table 6, Table 11, Table 22, Table 23, Table 27, Table 29, Table 30, Table 31, Table 32, Table 35, Table 38, Table 39, Table 40, Table 41, Table 43, Table 56, and Table 59.</li> <li>■ Various edits throughout to fix bugs.</li> <li>■ Changed title of document to <i>Stratix V Device Datasheet</i>.</li> <li>■ Removed document from the Stratix V handbook and made it a separate document.</li> </ul>                            |
| February 2012 | 2.3     | <ul style="list-style-type: none"> <li>■ Updated Table 1–22, Table 1–29, Table 1–31, and Table 1–31.</li> </ul>  |
| December 2011 | 2.2     | <ul style="list-style-type: none"> <li>■ Added Table 2–31.</li> <li>■ Updated Table 2–28 and Table 2–34.</li> </ul>  |
| November 2011 | 2.1     | <ul style="list-style-type: none"> <li>■ Added Table 2–2 and Table 2–21 and updated Table 2–5 with information about Stratix V GT devices.</li> <li>■ Updated Table 2–11, Table 2–13, Table 2–20, and Table 2–25.</li> <li>■ Various edits throughout to fix SPRs.</li> </ul>  |
| May 2011      | 2.0     | <ul style="list-style-type: none"> <li>■ Updated Table 2–4, Table 2–18, Table 2–19, Table 2–21, Table 2–22, Table 2–23, and Table 2–24.</li> <li>■ Updated the “DQ Logic Block and Memory Output Clock Jitter Specifications” title.</li> <li>■ Chapter moved to Volume 1.</li> <li>■ Minor text edits.</li> </ul>   |
| December 2010 | 1.1     | <ul style="list-style-type: none"> <li>■ Updated Table 1–2, Table 1–4, Table 1–19, and Table 1–23.</li> <li>■ Converted chapter to the new template.</li> <li>■ Minor text edits.</li> </ul>   |
| July 2010     | 1.0     | Initial release.   |